



**THE DATASHEET OF
SCP8PTF1HPLAPTK34E**



High Power LED Series Chip Scale Package

LH181A



Use of Samsung's Chip Scale Package technology
provide high performance and energy conserving



Features & Benefits

- Utilizes Samsung TF chip technology
- Suitable for use in indoor and outdoor lighting
- Compact footprint (1.91 x 1.91 mm)

Applications

- Indoor Lighting: Spotlight, Downlight, MR, PAR
- Outdoor Lighting: Street Light, Tunnel Light, Security Light, Parking Lot Light
- Industrial Lighting: High Bay Light, Low Bay Light
- Consumer Lighting: Torch Light

Table of Contents

| | | | |
|-----|-------------------------------------|-------|----|
| 1. | Characteristics | ----- | 3 |
| 2. | Product Code Information | ----- | 5 |
| 3. | Typical Characteristics Graphs | ----- | 14 |
| 4. | Outline Drawing & Dimension | ----- | 16 |
| 5. | Reliability Test Items & Conditions | ----- | 17 |
| 6. | Soldering Conditions | ----- | 18 |
| 7. | Tape & Reel | ----- | 19 |
| 8. | Label Structure | ----- | 21 |
| 9. | Packing Structure | ----- | 22 |
| 10. | Precautions in Handling & Use | ----- | 24 |

1. Characteristics

a) Absolute Maximum Rating

| Item | Symbol | Rating | Unit | Condition |
|---------------------------------|-----------|------------|---------|----------------------------|
| Ambient / Operating Temperature | T_a | -40 ~ +105 | °C | Note 1) |
| Storage Temperature | T_{stg} | -40 ~ +125 | °C | - |
| LED Junction Temperature | T_j | 150 | °C | - |
| Forward Current | I_F | 1500 | mA | - |
| Peak Pulse Forward Current | I_{FP} | 2000 | mA | Duty 1/10 pulse width 10ms |
| Assembly Process Temperature | - | 260 <10 | °C s | - |
| ESD (HBM) | - | ±2 | kV | - |

Note:

- 1) Refer to the derating curve, '3. Typical Characteristics Graph', for proper driving current that maintained below maximum junction temperature.

b) Electro-optical Characteristics

| Item | Unit | Nominal CCT (K) | Condition | | Value Typ. |
|--|------|--------------------|---------------------|---------------------|---------------|
| | | | I _F (mA) | T _J (°C) | |
| Luminous Flux (Φ _v) | lm | 5000 (70 CRI) | 350 | 25 | 172 |
| | | | 350 | 85 | 160 |
| | | | 700 | 85 | 290 |
| | | | 1000 | 85 | 383 |
| | | | 1500 | 85 | 489 |
| Forward Voltage (V _F) | V | | 350 | 25 | 2.92 |
| | | | 350 | 85 | 2.82 |
| | | | 700 | 85 | 2.97 |
| | | | 1000 | 85 | 3.08 |
| | | | 1500 | 85 | 3.15 |
| Thermal Resistance (junction to solder point) | °C/W | | | | 3 |
| Beam Angle | ° | | | | 140 |

Note:

Samsung maintains measurement tolerance of: luminous flux = ±7%, forward voltage = ±0.1 V

2. Product Code Information

| | | | | | | | | | | | | | | | | | |
|----------|----------|----------|----------|----------|----------|----------|----------|----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| <u>1</u> | <u>2</u> | <u>3</u> | <u>4</u> | <u>5</u> | <u>6</u> | <u>7</u> | <u>8</u> | <u>9</u> | <u>10</u> | <u>11</u> | <u>12</u> | <u>13</u> | <u>14</u> | <u>15</u> | <u>16</u> | <u>17</u> | <u>18</u> |
| S | C | P | 7 | R | T | F | 1 | H | P | L | A | R | T | M | 3 | 4 | E |

| Digit | PKG Information | Code | Specification | | | | | |
|-------|----------------------------|--|--|--|--|----------------------|--|--|
| 1 2 3 | Samsung Chip Scale Package | SCP | | | | | | |
| 4 | CRI | 7 8 9 | Min. 70 Min. 80 Min. 90 | | | | | |
| 5 | CCT | W V U T S R Q P | 2700K 3000K 3500K 4000K 4500K 5000K 5700K 6500K | | | | | |
| 6 | Chip Shape | T | Square type | | | | | |
| 7 8 9 | Product | F1H | Chip version | | | | | |
| 10 11 | CSP type | PL | PoC for lighting | | | | | |
| 12 | Product Purpose | A | PKG single product | | | | | |
| 13 14 | CCT (K) | W 0 V 0 U 0 T 0 S 0 R T Q T P T | 2700 3000 3500 4000 4500 5000 5700 6500 | Bin Co de: | W1, W2, W3, W4, W5, W6, W7, W8, W9, WA, WB, WC, WD, WE, WF, WG V1, V2, V3, V4, V5, V6, V7, V8, V9, VA, VB, VC, VD, VE, VF, VG U1, U2, U3, U4, U5, U6, U7, U8, U9, UA, UB, UC, UD, UE, UF, UG T1, T2, T3, T4, T5, T6, T7, T8, T9, TA, TB, TC, TD, TE, TF, TG S1, S2, S3, S4, S5, S6, S7, S8, S9, SA, SB, SC, SD, SE, SF, SG R1, R2, R3, R4 Q1, Q2, Q3, Q4 P1, P2, P3, P4 | | | |
| 15 16 | Luminous Flux | F 3 G 3 H 3 J 3 K 3 M 3 N 3 P 3 | 90~120 100~130 110~140 120~150 130~160 140~170 150~180 160~190 | F 1 G 1 H 1 J 1 K 1 M 1 N 1 P 1 | 90~100 100~110 110~120 120~130 130~140 140~150 150~160 160~170 | | | |
| | | | Digit 15: Min. spec Digit 16: The number of higher bin(s) from min. spec. e.g.: K1 = 130~140 lm, K3 = 130~160 lm | | | | | |
| 17 18 | Forward Voltage (Vf) | 4 E | 2.7 ~ 3.1 V | Bin Cdoe | 49 9E | 2.7~2.91 2.91~3.1 | | |

a) Luminous Flux Bins and Characteristics ($I_f = 350 \text{ mA}$, $T_s = 85^\circ\text{C}$)

| CRI (R_a) Min. ¹⁾ | Nominal CCT (K) | Product Code | Sorting @ 350 mA (lm) | | Calculated Minimum Flux ²⁾ (lm) | |
|-------------------------------------|----------------------------|---------------------------|-----------------------|--------------------------|--|-----------|
| | | | Flux Rank | Flux Range ¹⁾ | @ 700 mA | @ 1000 mA |
| 70 | 2700 | <i>SCP7WTF1HPLAW0J34E</i> | M1 | 140 ~ 150 | 257 | 339 |
| | | | K1 | 130 ~ 140 | 238 | 315 |
| | | | J1 | 120 ~ 130 | 220 | 291 |
| | 3000 | <i>SCP7VTF1HPLAV0K34E</i> | N1 | 150 ~ 160 | 275 | 363 |
| | | | M1 | 140 ~ 150 | 257 | 339 |
| | | | K1 | 130 ~ 140 | 238 | 315 |
| | 3500 | <i>SCP7UTF1HPLAU0K34E</i> | N1 | 150 ~ 160 | 275 | 363 |
| | | | M1 | 140 ~ 150 | 257 | 339 |
| | | | K1 | 130 ~ 140 | 238 | 315 |
| | 4000 | <i>SCP7TTF1HPLAT0M34E</i> | P1 | 160 ~ 170 | 293 | 388 |
| | | | N1 | 150 ~ 160 | 275 | 363 |
| | | | M1 | 140 ~ 150 | 257 | 339 |
| | 5000 | <i>SCP7RTF1HPLARTM34E</i> | P1 | 160 ~ 170 | 293 | 388 |
| | | | N1 | 150 ~ 160 | 275 | 363 |
| | | | M1 | 140 ~ 150 | 257 | 339 |
| | 5700 | <i>SCP7QTF1HPLAQTM34E</i> | P1 | 160 ~ 170 | 293 | 388 |
| | | | N1 | 150 ~ 160 | 275 | 363 |
| | | | M1 | 140 ~ 150 | 257 | 339 |
| 6500 | <i>SCP7PTF1HPLAPT M34E</i> | P1 | 160 ~ 170 | 293 | 388 | |
| | | N1 | 150 ~ 160 | 275 | 363 | |
| | | M1 | 140 ~ 150 | 257 | 339 | |

Notes:

- 1) Samsung maintains measurement tolerance of: luminous flux = $\pm 7\%$, CRI = ± 3
- 2) Calculated minimum and maximum flux values are for reference only

a) Luminous Flux Bins and Characteristics ($I_f = 350 \text{ mA}$, $T_s = 85^\circ\text{C}$)

| CRI (R_a) Min. ¹⁾ | Nominal CCT (K) | Product Code | Sorting @ 350 mA (lm) | | Calculated Minimum Flux ²⁾ (lm) | |
|-------------------------------------|---------------------------|---------------------------|-----------------------|--------------------------|--|-----------|
| | | | Flux Rank | Flux Range ¹⁾ | @ 700 mA | @ 1000 mA |
| 80 | 2700 | <i>SCP8WTF1HPLAW0J34E</i> | M1 | 140 ~ 150 | 257 | 339 |
| | | | K1 | 130 ~ 140 | 238 | 315 |
| | | | J1 | 120 ~ 130 | 220 | 291 |
| | 3000 | <i>SCP8VTF1HPLAV0K34E</i> | N1 | 150 ~ 160 | 275 | 363 |
| | | | M1 | 140 ~ 150 | 257 | 339 |
| | | | K1 | 130 ~ 140 | 238 | 315 |
| | 3500 | <i>SCP8UTF1HPLAU0K34E</i> | N1 | 150 ~ 160 | 275 | 363 |
| | | | M1 | 140 ~ 150 | 257 | 339 |
| | | | K1 | 130 ~ 140 | 238 | 315 |
| | 4000 | <i>SCP8TTF1HPLAT0K34E</i> | N1 | 150 ~ 160 | 275 | 363 |
| | | | M1 | 140 ~ 150 | 257 | 339 |
| | | | K1 | 130 ~ 140 | 238 | 315 |
| 5000 | <i>SCP8RTF1HPLARTK34E</i> | N1 | 150 ~ 160 | 275 | 363 | |
| | | M1 | 140 ~ 150 | 257 | 339 | |
| | | K1 | 130 ~ 140 | 238 | 315 | |
| 5700 | <i>SCP8QTF1HPLAQTK34E</i> | N1 | 150 ~ 160 | 275 | 363 | |
| | | M1 | 140 ~ 150 | 257 | 339 | |
| | | K1 | 130 ~ 140 | 238 | 315 | |
| 6500 | <i>SCP8PTF1HPLAPTK34E</i> | N1 | 150 ~ 160 | 275 | 363 | |
| | | M1 | 140 ~ 150 | 257 | 339 | |
| | | K1 | 130 ~ 140 | 238 | 315 | |
| 90 | 3000 | <i>SCP9VTF1HPLAV0G34E</i> | J1 | 120 ~ 130 | 220 | 291 |
| | | | H1 | 110 ~ 120 | 201 | 266 |
| | | | G1 | 100 ~ 110 | 184 | 243 |
| | 4000 | <i>SCP9TTF1HPLAT0G34E</i> | J1 | 120 ~ 130 | 220 | 291 |
| | | | H1 | 110 ~ 120 | 201 | 266 |
| | | | G1 | 100 ~ 110 | 184 | 243 |

Notes:

- 1) Samsung maintains measurement tolerance of: luminous flux = $\pm 7\%$, CRI = ± 3
- 2) Calculated minimum and maximum flux values are for reference only

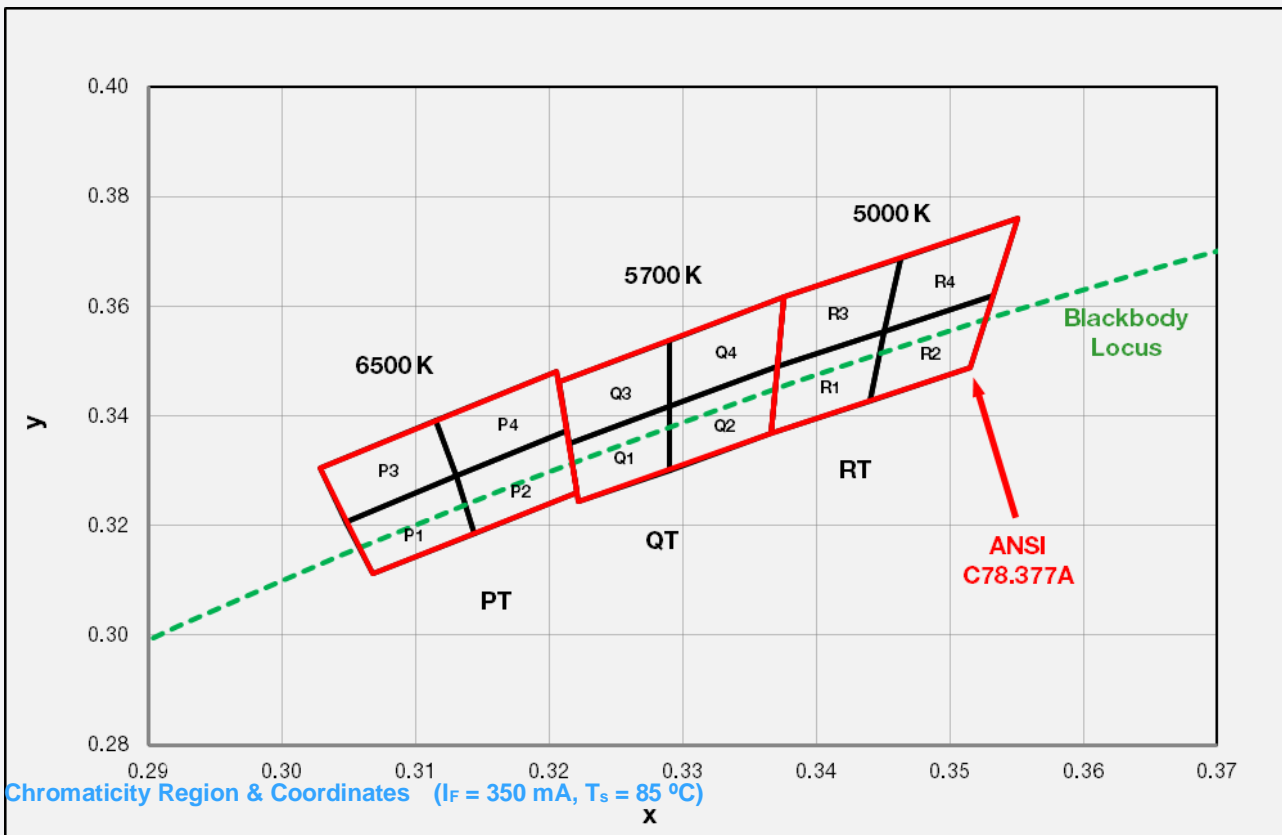
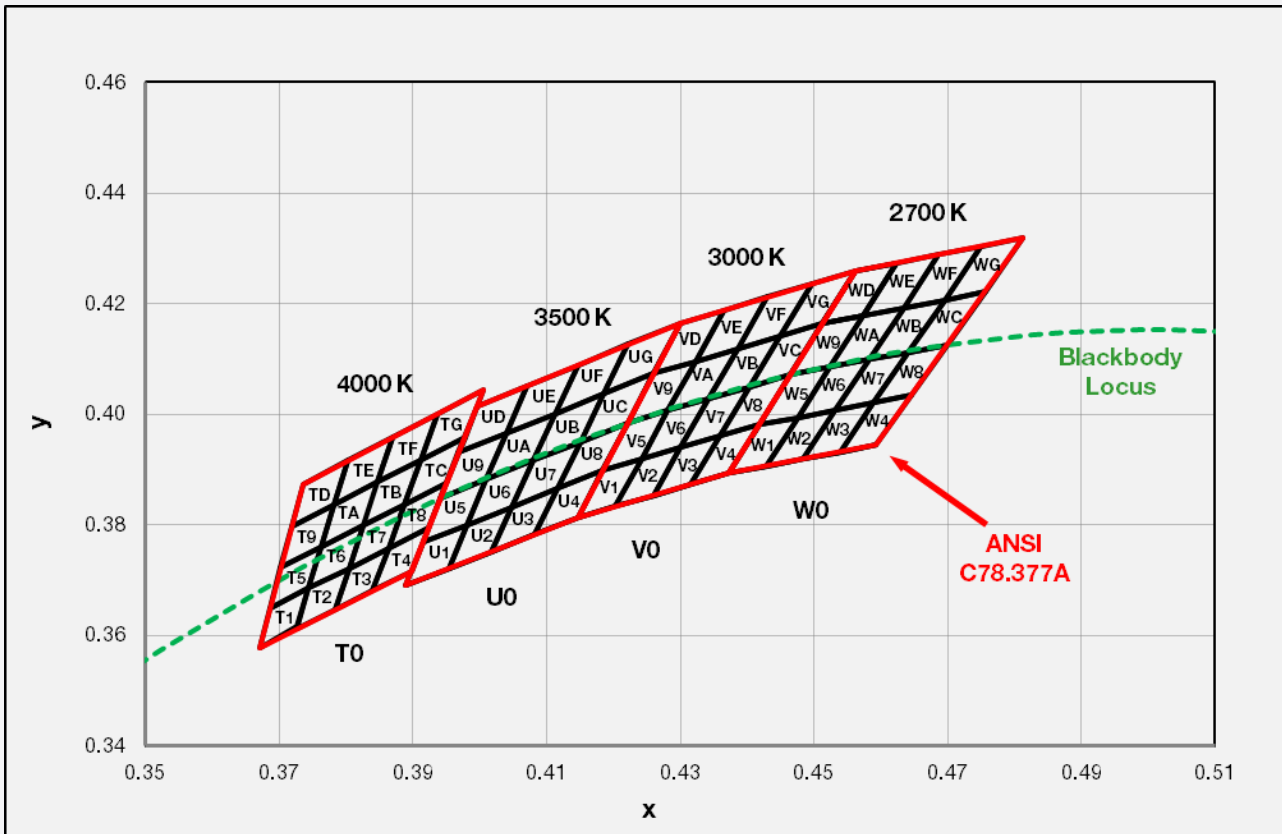
b) Color Bins ($I_F = 350 \text{ mA}$, $T_s = 85 \text{ }^\circ\text{C}$)

| CRI (Ra) Min. | Nominal CCT (K) | Product Code | Color Rank | Chromaticity Bins |
|------------------|--------------------|---------------------------|-------------------|---|
| 70 | 2700 | <i>SCP7WTF1HPLAW0J34E</i> | W0 (Whole bin) | V1, V2, V3, V4, V5, V6, V7, V8, V9, VA, VB, VC, VD, VE, VF, VG |
| | 3000 | <i>SCP7VTF1HPLAV0K34E</i> | V0 (Whole bin) | V1, V2, V3, V4, V5, V6, V7, V8, V9, VA, VB, VC, VD, VE, VF, VG |
| | 3500 | <i>SCP7UTF1HPLAU0K34E</i> | U0 (Whole bin) | U1, U2, U3, U4, U5, U6, U7, U8, U9, UA, UB, UC, UD, UE, UF, UG |
| | 4000 | <i>SCP7TTF1HPLAT0M34E</i> | T0 (Whole bin) | T1, T2, T3, T4, T5, T6, T7, T8, T9, TA, TB, TC, TD, TE, TF, TG |
| | 5000 | <i>SCP7RTF1HPLARTM34E</i> | RT (ANSI bin) | R1, R2, R3, R4 |
| | 5700 | <i>SCP7QTF1HPLAQTM34E</i> | QT (ANSI bin) | Q1, Q2, Q3, Q4 |
| | 6500 | <i>SCP7PTF1HPLAPTM34E</i> | PT (ANSI bin) | P1, P2, P3, P4 |
| 80 | 2700 | <i>SCP8WTF1HPLAW0J34E</i> | W0 (Whole bin) | W1, W2, W3, W4, W5, W6, W7, W8, W9, WA, WB, WC, WD, WE, WF, WG |
| | 3000 | <i>SCP8VTF1HPLAV0K34E</i> | V0 (Whole bin) | V1, V2, V3, V4, V5, V6, V7, V8, V9, VA, VB, VC, VD, VE, VF, VG |
| | 3500 | <i>SCP8UTF1HPLAU0K34E</i> | U0 (Whole bin) | U1, U2, U3, U4, U5, U6, U7, U8, U9, UA, UB, UC, UD, UE, UF, UG |
| | 4000 | <i>SCP8TTF1HPLAT0K34E</i> | T0 (Whole bin) | T1, T2, T3, T4, T5, T6, T7, T8, T9, TA, TB, TC, TD, TE, TF, TG |
| | 5000 | <i>SCP8RTF1HPLARTK34E</i> | RT (ANSI bin) | R1, R2, R3, R4 |
| | 5700 | <i>SCP8QTF1HPLAQTK34E</i> | QT (ANSI bin) | Q1, Q2, Q3, Q4 |
| | 6500 | <i>SCP8PTF1HPLAPTK34E</i> | PT (ANSI bin) | P1, P2, P3, P4 |
| 90 | 3000 | <i>SCP9VTF1HPLAV0G34E</i> | V0 (Whole bin) | V1, V2, V3, V4, V5, V6, V7, V8, V9, VA, VB, VC, VD, VE, VF, VG |
| | 4000 | <i>SCP9TTF1HPLAV0G34E</i> | T0 (Whole bin) | T1, T2, T3, T4, T5, T6, T7, T8, T9, TA, TB, TC, TD, TE, TF, TG |

c) Voltage Bins ($I_F = 350 \text{ mA}$, $T_s = 85 \text{ °C}$)

| CRI (Ra) Min. | Nominal CCT (K) | Product Code | Voltage Rank | Voltage Bin | Voltage Range (V) |
|------------------|--------------------|--------------|--------------|-------------|----------------------|
| | | | | 49 | 2.7 ~ 2.91 |
| | | | 4E | | |
| | | | | 9E | 2.91 ~ 3.1 |

d) Chromaticity Region & Coordinates ($I_f = 350 \text{ mA}$, $T_s = 85 \text{ }^\circ\text{C}$)



d) Chromaticity Region & Coordinates ($I_f = 350 \text{ mA}$, $T_s = 85 \text{ }^\circ\text{C}$)

| Region | CIE x | CIE y | Region | CIE x | CIE y |
|------------------------|--------|--------|--------|--------|--------|
| W rank (2700 K) | | | | | |
| W1 | 0.4373 | 0.3893 | W9 | 0.4465 | 0.4071 |
| | 0.4418 | 0.3981 | | 0.4513 | 0.4164 |
| | 0.4475 | 0.3994 | | 0.4573 | 0.4178 |
| | 0.4428 | 0.3906 | | 0.4523 | 0.4085 |
| W2 | 0.4428 | 0.3906 | WA | 0.4523 | 0.4085 |
| | 0.4475 | 0.3994 | | 0.4573 | 0.4178 |
| | 0.4532 | 0.4008 | | 0.4634 | 0.4193 |
| | 0.4483 | 0.3919 | | 0.4582 | 0.4099 |
| W3 | 0.4483 | 0.3919 | WB | 0.4582 | 0.4099 |
| | 0.4532 | 0.4008 | | 0.4634 | 0.4193 |
| | 0.4589 | 0.4021 | | 0.4695 | 0.4207 |
| | 0.4538 | 0.3931 | | 0.4641 | 0.4112 |
| W4 | 0.4538 | 0.3931 | WC | 0.4641 | 0.4112 |
| | 0.4589 | 0.4021 | | 0.4695 | 0.4207 |
| | 0.4646 | 0.4034 | | 0.4756 | 0.4221 |
| | 0.4593 | 0.3944 | | 0.4700 | 0.4126 |
| W5 | 0.4418 | 0.3981 | WD | 0.4513 | 0.4164 |
| | 0.4465 | 0.4071 | | 0.4562 | 0.4260 |
| | 0.4523 | 0.4085 | | 0.4624 | 0.4274 |
| | 0.4475 | 0.3994 | | 0.4573 | 0.4178 |
| W6 | 0.4475 | 0.3994 | WE | 0.4573 | 0.4178 |
| | 0.4523 | 0.4085 | | 0.4624 | 0.4274 |
| | 0.4582 | 0.4099 | | 0.4687 | 0.4289 |
| | 0.4532 | 0.4008 | | 0.4634 | 0.4193 |
| W7 | 0.4532 | 0.4008 | WF | 0.4634 | 0.4193 |
| | 0.4582 | 0.4099 | | 0.4687 | 0.4289 |
| | 0.4641 | 0.4112 | | 0.4750 | 0.4304 |
| | 0.4589 | 0.4021 | | 0.4695 | 0.4207 |
| W8 | 0.4589 | 0.4021 | WG | 0.4695 | 0.4207 |
| | 0.4641 | 0.4112 | | 0.4750 | 0.4304 |
| | 0.4700 | 0.4126 | | 0.4813 | 0.4319 |
| | 0.4646 | 0.4034 | | 0.4756 | 0.4221 |

| V rank (3000 K) | | | | | |
|------------------------|--------|--------|----|--------|--------|
| V1 | 0.4147 | 0.3814 | V9 | 0.4221 | 0.3984 |
| | 0.4183 | 0.3898 | | 0.4259 | 0.4073 |
| | 0.4242 | 0.3919 | | 0.4322 | 0.4096 |
| V2 | 0.4203 | 0.3833 | VA | 0.4281 | 0.4006 |
| | 0.4242 | 0.3919 | | 0.4322 | 0.4096 |
| | 0.4300 | 0.3939 | | 0.4385 | 0.4119 |
| V3 | 0.4259 | 0.3853 | VB | 0.4342 | 0.4028 |
| | 0.4300 | 0.3939 | | 0.4385 | 0.4119 |
| | 0.4359 | 0.3960 | | 0.4449 | 0.4141 |
| V4 | 0.4316 | 0.3873 | VC | 0.4403 | 0.4049 |
| | 0.4359 | 0.3960 | | 0.4449 | 0.4141 |
| | 0.4418 | 0.3981 | | 0.4513 | 0.4164 |
| V5 | 0.4373 | 0.3893 | VD | 0.4465 | 0.4071 |
| | 0.4183 | 0.3898 | | 0.4259 | 0.4073 |
| | 0.4221 | 0.3984 | | 0.4299 | 0.4165 |
| V6 | 0.4281 | 0.4006 | VE | 0.4364 | 0.4188 |
| | 0.4342 | 0.4028 | | 0.4322 | 0.4096 |
| | 0.4300 | 0.3939 | | 0.4364 | 0.4188 |
| V7 | 0.4300 | 0.3939 | VF | 0.4430 | 0.4212 |
| | 0.4342 | 0.4028 | | 0.4385 | 0.4119 |
| | 0.4403 | 0.4049 | | 0.4430 | 0.4212 |
| V8 | 0.4359 | 0.3960 | VG | 0.4496 | 0.4236 |
| | 0.4359 | 0.3960 | | 0.4449 | 0.4141 |
| | 0.4403 | 0.4049 | | 0.4496 | 0.4236 |
| | 0.4465 | 0.4071 | | 0.4562 | 0.4260 |
| | 0.4418 | 0.3981 | | 0.4513 | 0.4164 |

| Region | CIE x | CIE y | Region | CIE x | CIE y |
|--------|-------|-------|--------|-------|-------|
|--------|-------|-------|--------|-------|-------|

d) Chromaticity Region & Coordinates

| Region | CIE x | CIE y | Region | CIE x | CIE y |
|------------------------|--------|--------|--------|--------|--------|
| U rank (3500 K) | | | | | |
| U1 | 0.3889 | 0.3690 | U9 | 0.3941 | 0.3848 |
| | 0.3915 | 0.3768 | | 0.3968 | 0.3930 |
| | 0.3981 | 0.3800 | | 0.4040 | 0.3966 |
| | 0.3953 | 0.3720 | | 0.4010 | 0.3882 |
| U2 | 0.3953 | 0.3720 | UA | 0.4010 | 0.3882 |
| | 0.3981 | 0.3800 | | 0.4040 | 0.3966 |
| | 0.4048 | 0.3832 | | 0.4113 | 0.4001 |
| | 0.4017 | 0.3751 | | 0.4080 | 0.3916 |
| U3 | 0.4017 | 0.3751 | UB | 0.4080 | 0.3916 |
| | 0.4048 | 0.3832 | | 0.4113 | 0.4001 |
| | 0.4116 | 0.3865 | | 0.4186 | 0.4037 |
| | 0.4082 | 0.3782 | | 0.4150 | 0.3950 |
| U4 | 0.4082 | 0.3782 | UC | 0.4150 | 0.3950 |
| | 0.4116 | 0.3865 | | 0.4186 | 0.4037 |
| | 0.4183 | 0.3898 | | 0.4259 | 0.4073 |
| | 0.4147 | 0.3814 | | 0.4221 | 0.3984 |
| U5 | 0.3915 | 0.3768 | UD | 0.3968 | 0.3930 |
| | 0.3941 | 0.3848 | | 0.3996 | 0.4015 |
| | 0.4010 | 0.3882 | | 0.4071 | 0.4052 |
| | 0.3981 | 0.3800 | | 0.4040 | 0.3966 |
| U6 | 0.3981 | 0.3800 | UE | 0.4040 | 0.3966 |
| | 0.4010 | 0.3882 | | 0.4071 | 0.4052 |
| | 0.4080 | 0.3916 | | 0.4146 | 0.4089 |
| | 0.4048 | 0.3832 | | 0.4113 | 0.4001 |
| U7 | 0.4048 | 0.3832 | UF | 0.4113 | 0.4001 |
| | 0.4080 | 0.3916 | | 0.4146 | 0.4089 |
| | 0.4150 | 0.3950 | | 0.4222 | 0.4127 |
| | 0.4116 | 0.3865 | | 0.4186 | 0.4037 |
| U8 | 0.4116 | 0.3865 | UG | 0.4186 | 0.4037 |
| | 0.4150 | 0.3950 | | 0.4222 | 0.4127 |
| | 0.4221 | 0.3984 | | 0.4299 | 0.4165 |
| | 0.4183 | 0.3898 | | 0.4259 | 0.4073 |

| Region | CIE x | CIE y | Region | CIE x | CIE y |
|------------------------|--------|--------|--------|--------|--------|
| T rank (4000 K) | | | | | |
| T1 | 0.3670 | 0.3578 | T9 | 0.3702 | 0.3722 |
| | 0.3726 | 0.3612 | | 0.3763 | 0.3760 |
| | 0.3744 | 0.3685 | | 0.3782 | 0.3837 |
| | 0.3686 | 0.3649 | | 0.3719 | 0.3797 |
| T2 | 0.3726 | 0.3612 | TA | 0.3763 | 0.3760 |
| | 0.3783 | 0.3646 | | 0.3825 | 0.3798 |
| | 0.3804 | 0.3721 | | 0.3847 | 0.3877 |
| | 0.3744 | 0.3685 | | 0.3782 | 0.3837 |
| T3 | 0.3783 | 0.3646 | TB | 0.3825 | 0.3798 |
| | 0.3840 | 0.3681 | | 0.3887 | 0.3836 |
| | 0.3863 | 0.3758 | | 0.3912 | 0.3917 |
| | 0.3804 | 0.3721 | | 0.3847 | 0.3877 |
| T4 | 0.3840 | 0.3681 | TC | 0.3887 | 0.3837 |
| | 0.3898 | 0.3716 | | 0.3950 | 0.3875 |
| | 0.3924 | 0.3794 | | 0.3978 | 0.3958 |
| | 0.3863 | 0.3758 | | 0.3912 | 0.3917 |
| T5 | 0.3686 | 0.3649 | TD | 0.3719 | 0.3797 |
| | 0.3744 | 0.3685 | | 0.3782 | 0.3837 |
| | 0.3763 | 0.3760 | | 0.3802 | 0.3916 |
| | 0.3702 | 0.3722 | | 0.3736 | 0.3874 |
| T6 | 0.3744 | 0.3685 | TE | 0.3782 | 0.3837 |
| | 0.3804 | 0.3721 | | 0.3847 | 0.3877 |
| | 0.3825 | 0.3798 | | 0.3869 | 0.3958 |
| | 0.3763 | 0.376 | | 0.3802 | 0.3916 |
| T7 | 0.3804 | 0.3721 | TF | 0.3847 | 0.3877 |
| | 0.3863 | 0.3758 | | 0.3912 | 0.3917 |
| | 0.3887 | 0.3836 | | 0.3937 | 0.4001 |
| | 0.3825 | 0.3798 | | 0.3869 | 0.3958 |
| T8 | 0.3863 | 0.3758 | TG | 0.3912 | 0.3917 |
| | 0.3924 | 0.3794 | | 0.3978 | 0.3958 |
| | 0.3950 | 0.3875 | | 0.4006 | 0.4044 |
| | 0.3887 | 0.3836 | | 0.3937 | 0.4001 |

d) Chromaticity Region & Coordinates

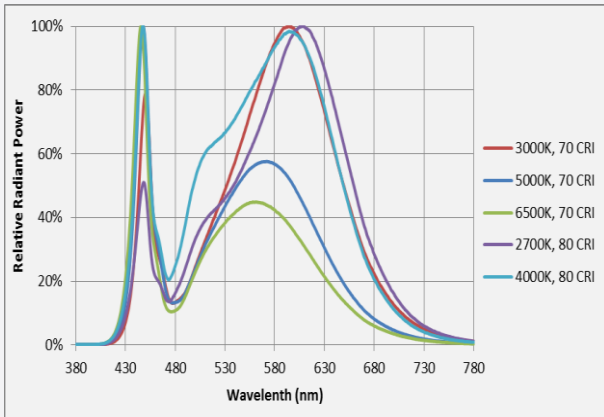
| Region | CIE x | CIE y | Region | CIE x | CIE y | Region | CIE x | CIE y |
|------------------------|--------|--------|------------------------|--------|--------|------------------------|--------|--------|
| R rank (5000 K) | | | Q rank (5700 K) | | | P rank (6500 K) | | |
| R1 | 0.3371 | 0.3490 | Q1 | 0.3215 | 0.3350 | P1 | 0.3068 | 0.3113 |
| | 0.3451 | 0.3554 | | 0.3290 | 0.3417 | | 0.3144 | 0.3186 |
| | 0.3440 | 0.3427 | | 0.3290 | 0.3300 | | 0.3130 | 0.3290 |
| | 0.3366 | 0.3369 | | 0.3222 | 0.3243 | | 0.3048 | 0.3207 |
| R2 | 0.3451 | 0.3554 | Q2 | 0.3290 | 0.3417 | P2 | 0.3144 | 0.3186 |
| | 0.3533 | 0.3620 | | 0.3371 | 0.3490 | | 0.3221 | 0.3261 |
| | 0.3515 | 0.3487 | | 0.3366 | 0.3369 | | 0.3213 | 0.3373 |
| | 0.3440 | 0.3427 | | 0.3290 | 0.3300 | | 0.3130 | 0.3290 |
| R3 | 0.3376 | 0.3616 | Q3 | 0.3207 | 0.3462 | P3 | 0.3048 | 0.3207 |
| | 0.3463 | 0.3687 | | 0.3290 | 0.3538 | | 0.3130 | 0.3290 |
| | 0.3451 | 0.3554 | | 0.3290 | 0.3417 | | 0.3115 | 0.3391 |
| | 0.3371 | 0.3490 | | 0.3215 | 0.3350 | | 0.3028 | 0.3304 |
| R4 | 0.3463 | 0.3687 | Q4 | 0.3290 | 0.3538 | P4 | 0.3130 | 0.3290 |
| | 0.3551 | 0.3760 | | 0.3376 | 0.3616 | | 0.3213 | 0.3373 |
| | 0.3533 | 0.3620 | | 0.3371 | 0.3490 | | 0.3205 | 0.3481 |
| | 0.3451 | 0.3554 | | 0.3290 | 0.3417 | | 0.3115 | 0.3391 |

Note:

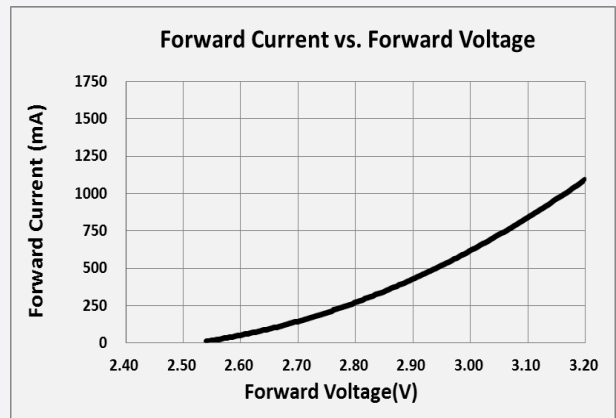
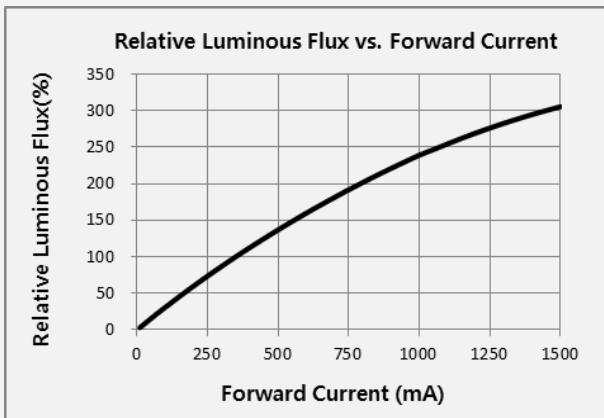
Samsung maintains measurement tolerance of: $C_x, C_y = \pm 0.005$

3. Typical Characteristics Graphs

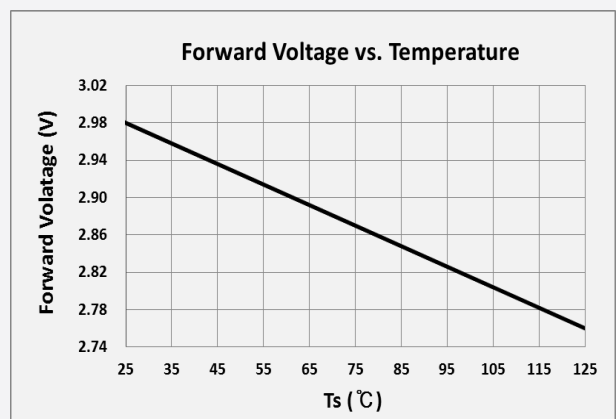
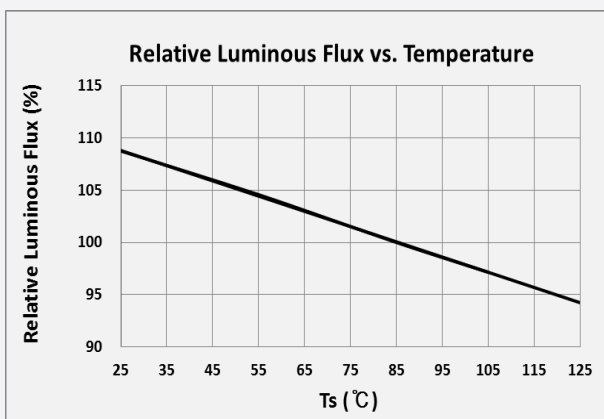
a) Spectrum Distribution ($I_F = 350 \text{ mA}$, $T_s = 85 \text{ }^\circ\text{C}$)



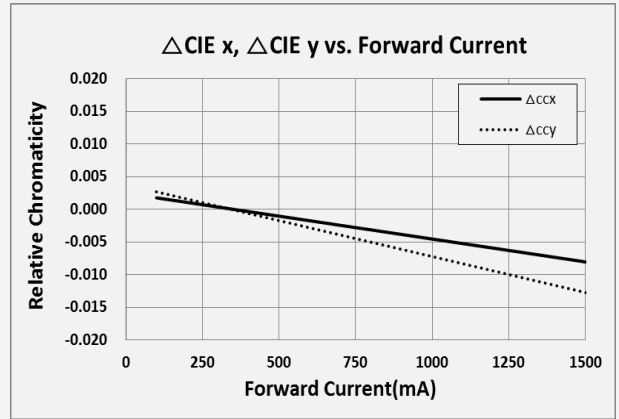
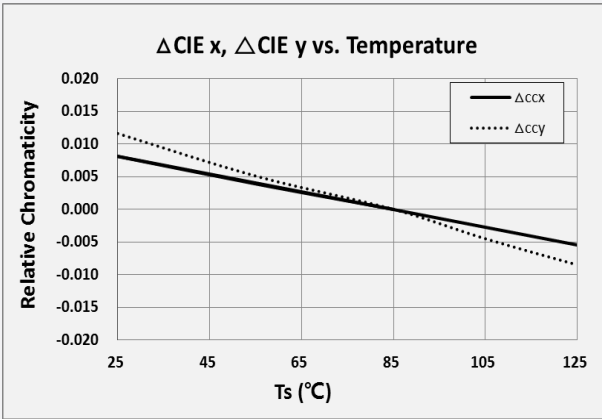
b) Forward Current Characteristics ($T_s = 85 \text{ }^\circ\text{C}$)



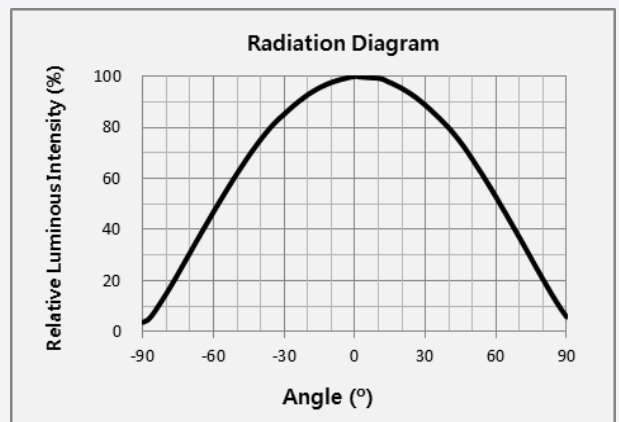
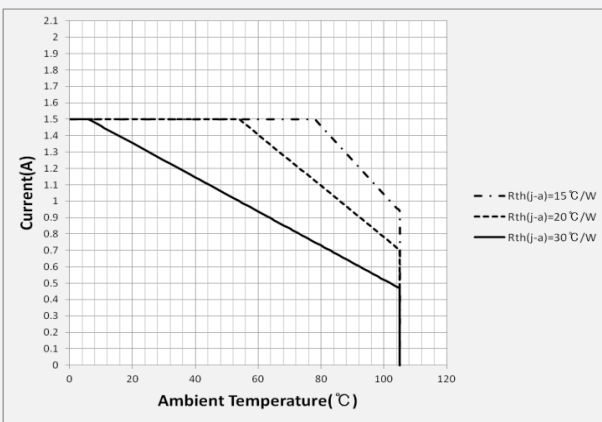
c) Temperature Characteristics ($I_F = 350 \text{ mA}$)



d) Color Shift Characteristics ($I_F = 350 \text{ mA}$, $T_s = 85 \text{ }^\circ\text{C}$)

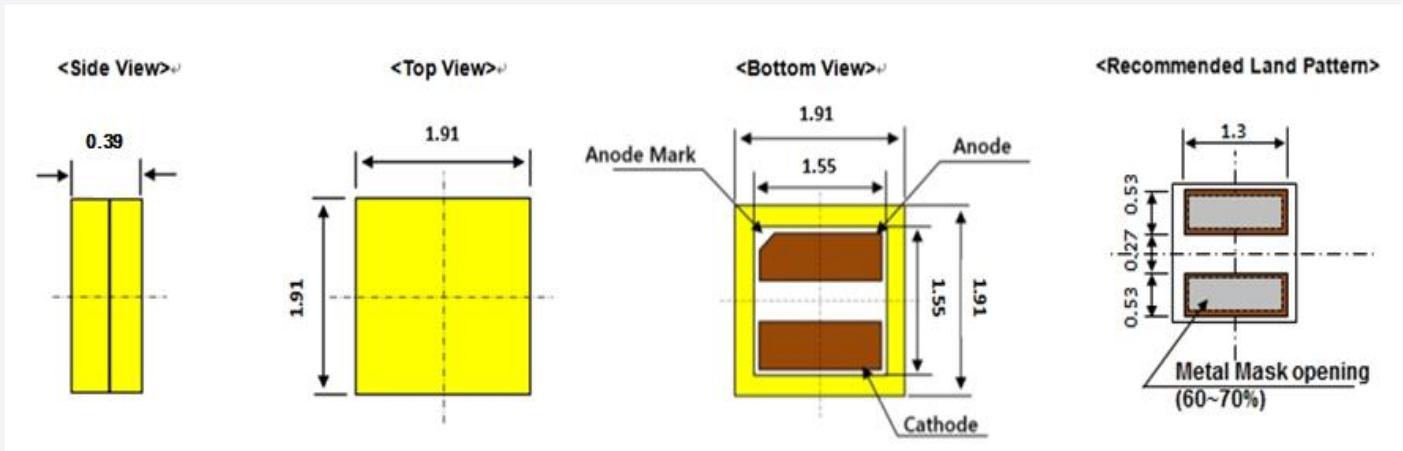


e) Derating Curve and Beam Angle Characteristics ($I_F = 350 \text{ mA}$, $T_s = 25 \text{ }^\circ\text{C}$)



4. Outline Drawing & Dimension

1. Tolerance is ± 0.10 mm
2. Do not place LEDs with pressure



Precautions:

- 1) Pressure on the LEDs will influence to the reliability of the LEDs. Precautions should be taken to avoid strong pressure on the LEDs. Do not put stress on the LEDs during heating.
- 2) Re-soldering should not be done after the LEDs have been soldered. If re-soldering is unavoidable, LED's characteristics should be carefully checked before and after such repair.
- 3) Do not stack assembled PCBs together. Since materials of LEDs is soft, abrasion between two PCB assembled with LED might cause catastrophic failure of the LEDs.

5. Reliability Test Items & Conditions

a) Test Items

| Test Item | Test Condition | Test Hour / Cycle | Sample Size |
|-------------------------------------|---|---|-------------|
| Room Temperature Life Test | 25 °C, Derating maximum current | 1000 h | 22 |
| High Temperature Life Test | 85 °C, Derating maximum current | 1000 h | 22 |
| High Temperature Humidity Life Test | 60 °C, 90% RH, Derating maximum current | 1000 h | 22 |
| Low Temperature Life Test | -40 °C, Derating maximum current | 1000 h | 22 |
| Temperature Humidity Cycle Test | -10 °C ↔ 25 °C 95 % RH ↔ 65 °C 95 % RH Derating maximum current | 10 cycles | 11 |
| Powered Temperature Cycle Test | -40 °C / 85 °C each 20 min, 100 min transfer power on/off each 5 min, Derating maximum current | 100 cycles | 11 |
| Thermal Shock | -45 °C / 15 min ↔ 125 °C / 15 min temperature change within 5 min | 500 cycles | 100 |
| High Temperature Storage | 120 °C | 1000 h | 11 |
| Low Temperature Storage | -40 °C | 1000 h | 11 |
| ESD (HBM) | <p>R₁: 10 MΩ R₂: 1.5 kΩ C: 100 pF V: ±2 kV</p> | 5 times | 30 |
| ESD (MM) | | R ₁ : 10 MΩ R ₂ : 0 C: 200 pF V: ±0.2 kV | 5 times |
| Vibration Test | 20~2000~20 Hz, 200 m/s ² , sweep 4 min X, Y, Z 3 direction, each 1 cycle | 4 cycles | 11 |
| Mechanical Shock Test | 1500 g, 0.5 ms 3 shocks each X-Y-Z axis | 5 cycles | 11 |

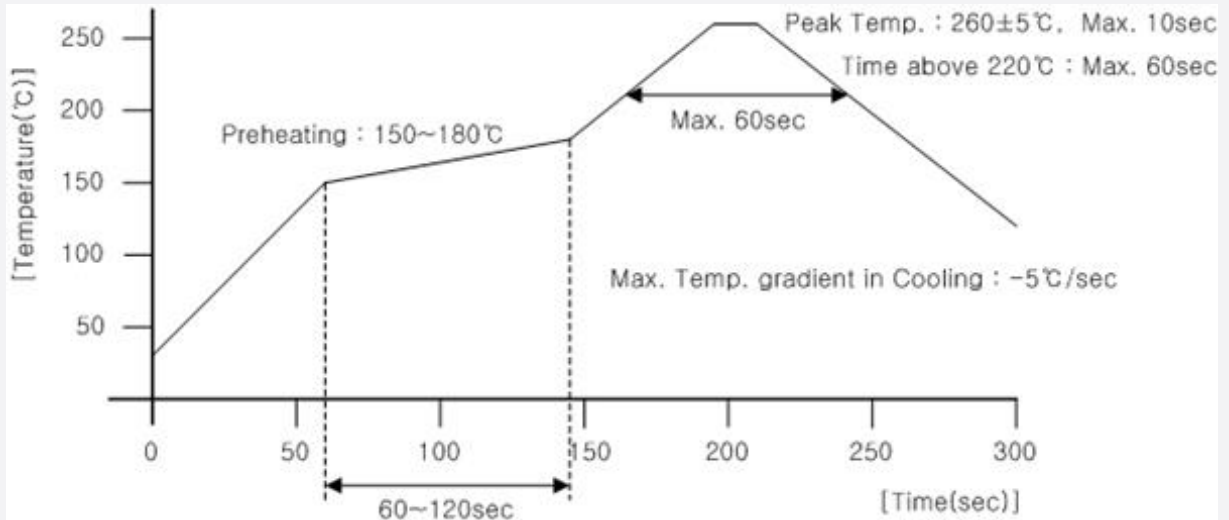
b) Criteria for Judging the Damage

| Item | Symbol | Test Condition (T _s = 25 °C) | Limit | |
|-----------------|----------------|--|-------------------|-------------------|
| | | | Min. | Max. |
| Forward Voltage | V _F | I _F = 350 mA | Init. Value * 0.9 | Init. Value * 1.1 |
| Luminous Flux | Φ _v | I _F = 350 mA | Init. Value * 0.7 | Init. Value * 1.1 |

6. Soldering Conditions

a) Reflow Conditions (Pb free)

Reflow frequency: 2 times max.

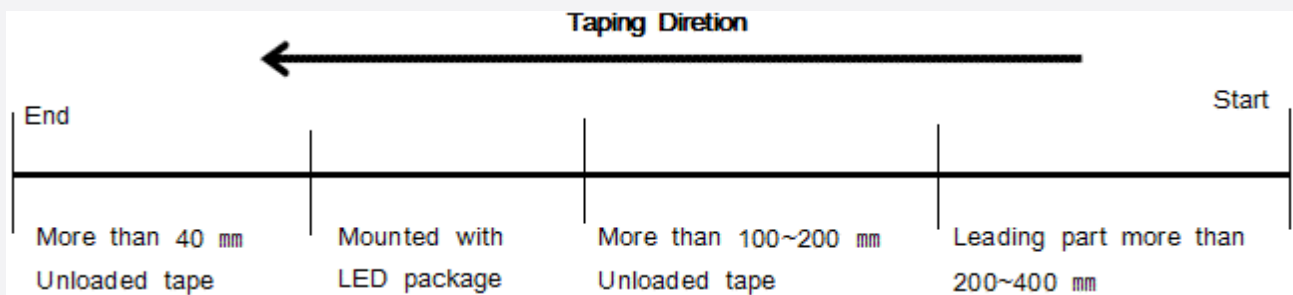
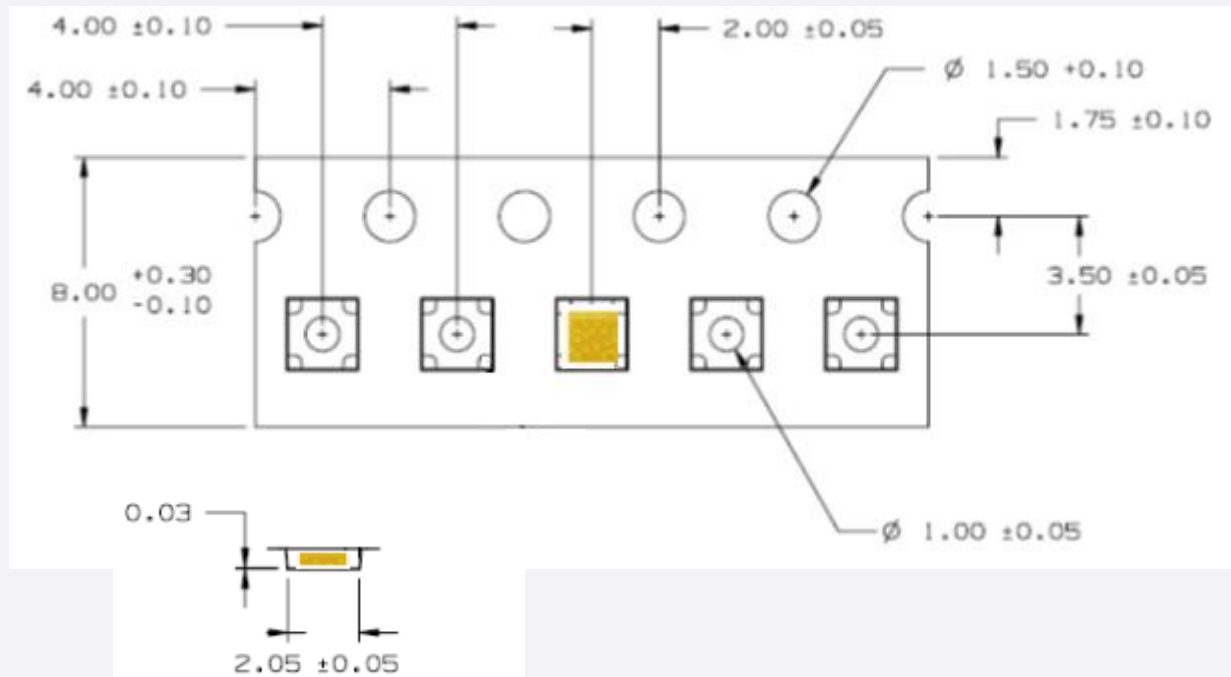


b) Manual Soldering Conditions

No more than 5 seconds @ max. 300 °C, under soldering iron.

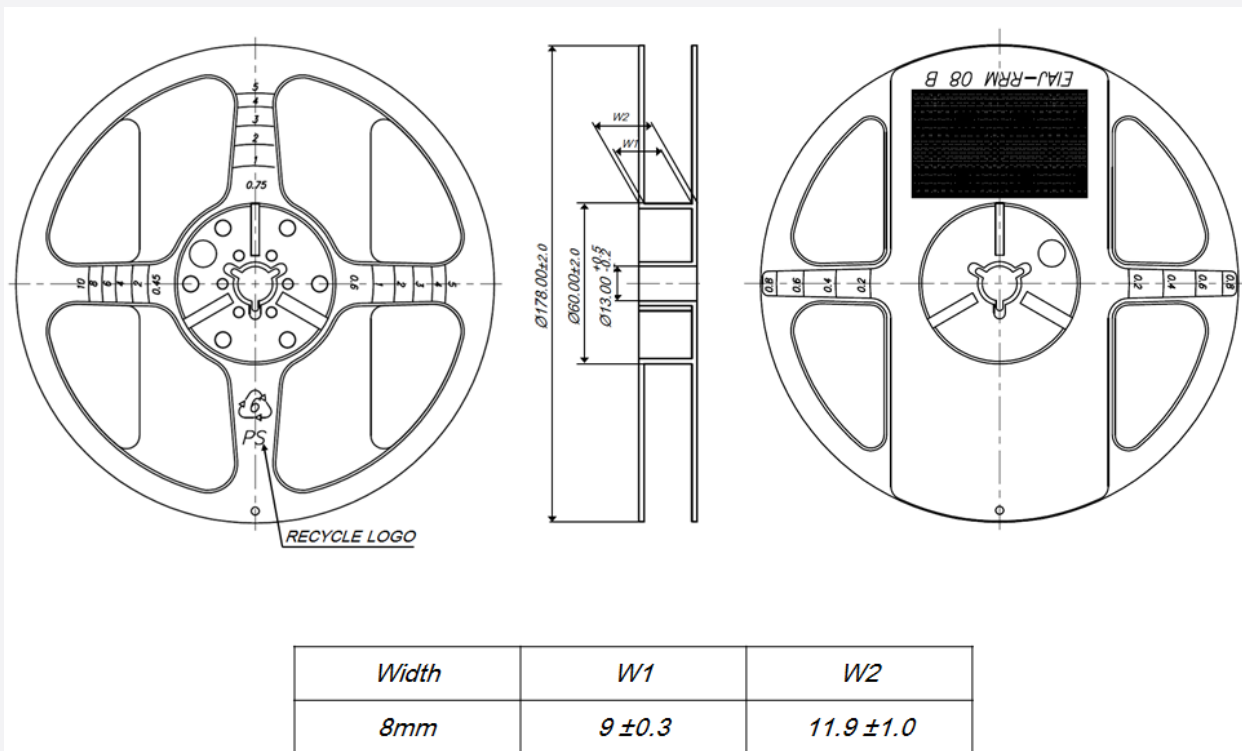
7. Tape & Reel

a) Taping Dimension



b) Reel Dimension

(unit: mm)

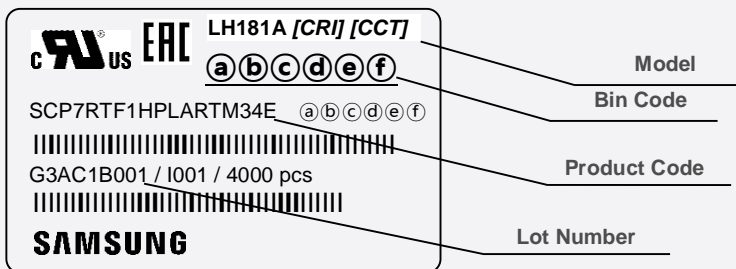


Notes:

- 1) Quantity: The quantity/reel is 4,000 pcs
- 2) Cumulative tolerance: Cumulative tolerance / 10 pitches is ±0.2 mm
- 3) Adhesion strength of cover tape: Adhesion strength is 0.1-0.7 N when the cover tape is turned off from the carrier tape at 10° angle to the carrier tape
- 4) Packaging: P/N, Manufacturing data code no. and quantity are indicated on the aluminum packing bag

8. Label Structure

a) Label Structure



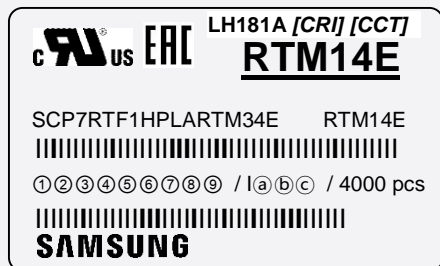
Note: Denoted bin code and product code above is only an example (see description on page -)

Bin Code:

- ⒶⒷ: Chromaticity bin (refer to page 11)
- ⒸⒹ: Luminous Flux bin (refer to page 6-7)
- ⒺⒻ: Voltage bin (refer to page 9)

b) Lot Number

The lot number is composed of the following characters:




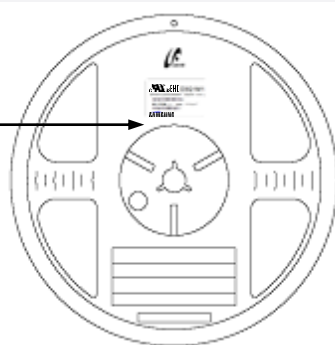
- ①② : Production site (G3 : Shenzhen, China, G4 :Guangzhou, China, GB : Nanchang, China)
- ③ : Product state (A : Normal, B : Bulk, C : First Production, R : Reproduction, S : Sample)
- ④ : Year (Y : 2014, Z : 2015, A : 2016, ...)
- ⑤ : Month (1, 2, ..., 7: July, ..., A: Oct., B: Nov., C: Dec.)
- ⑥ : Day (1~9, A: 10, ..., K: 20, ..., U: 30, V:31)
- ⑦⑧⑨ : Product serial number (001 ~ 999)
- ⒶⒷⒸ : Reel number (001~999) or (AAA~ZZZ)

9. Packing Structure


a) Packing Process

Reel


LH181A [CRI] [CCT]
RTM14E
 SCP7RTF1HPLARTM34E RTM14E
 G3AC1B001 / I001 / 4000 pcs
SAMSUNG



Aluminum Vinyl Packing Bag



LH181A [CRI] [CCT]
RTM14E
 SCP7RTF1HPLARTM34E RTM14E
 G3AC1B001 / I001 / 4000 pcs
SAMSUNG

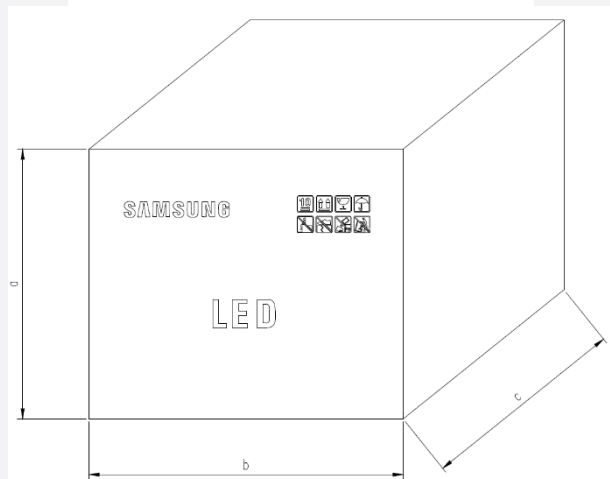


Outer Box


Material: Paper SW(B)

| Type | Size (mm) | | | Note |
|--------|-----------|---------|---------|----------------|
| | (a) | (b) | (c) | |
| 7 inch | 245 ± 5 | 220 ± 5 | 182 ± 5 | Up to 10 reels |


LH181A [CRI] [CCT]
RTM14E
 SCP7RTF1HPLARTM34E RTM14E
 G3AC1B001 / I001 / 4000 pcs
SAMSUNG



b) Aluminum Vinyl Packing Bag



CAUTION

This bag contains
MOISTURE SENSITIVE DEVICES

LEVEL

2a

1. Shelf life in sealed bag: 12 months at <40°C and <90% relative humidity (RH)
2. Peak package body temperature: 240 °C
3. After this bag is opened, devices that will be subjected to reflow solder or other high temperature processes must be:
 - a. Mounted within 672 hours at factory conditions of equal to or less than 30°C /60% RH, or
 - b. Stored at <10% RH
4. Devices require bake, before mounting, if:
 - a. Humidity Indicator Card is > 65% when read at 23±5°C, or
 - b. 2a is not met.
5. If baking is required, devices must be baked for 1 hours at 60±5°C

Note: if device containers cannot be subjected to high temperature or shorter bake times are desired, reference IPC/JEDEC J-STD-033 for bake procedure.

Bag seal due date: _____
(if blank, see code label)

Note: Level and body temperature by IPC/JEDEC J-STD-020

c

us

EAC

LH181A [CRI] [CCT]

RTM14E

SCP7RTF1HPLARTM34E RTM14E
 |||
 G3AC1B001 / I001 / 4000 pcs
 |||
SAMSUNG



주의 사항

이 알루미늄 지퍼 백은 습기 및 정전기로부터 제품을 보호하기 위하여 제작되었습니다. 개봉 후에는 즉시 솔더 작업을 실시하는 것을 권장합니다.

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Important

This Al Zipper bag is designed to protect the enclosed products from moisture and ESD. Once opened, the products should be soldered onto the printed circuit board immediately. When not in use, please do not leave the products unprotected by the Al Zipper Bag. To repack unused products., please ensure the zip-lock is completely sealed with the dry pack left inside.

c) Silica Gel & Humidity Indicator Card inside Aluminum Vinyl Bag



HUMISAFE™

10% 20% 30% 40% 50% 60%



READ AT TOP OF GREEN COLOR
CHANGE BETWEEN YELLOW AND GREEN

Warning If Green Change Desiccant

GP&E Co., Ltd.
6CF-60NS

10. Precautions in Handling & Use

- 1) For over-current protection, users are recommended to apply resistors connected in series with the LEDs to mitigate sudden change of the forward current caused by shift of forward voltage.
- 2) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the device.
- 3) When the device is in operation, the forward current should be carefully determined considering the maximum ambient temperature and corresponding junction temperature.
- 4) LEDs must be stored in a clean environment.
- 5) After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
 - a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 °C / 60 % RH, or
 - b. Stored at <10 % RH
- 6) Repack unused devices with anti-moisture packing, fold to close any opening and then store in a dry place.
- 7) Devices require baking before mounting, if humidity card reading is >60 % at 23 ± 5 °C.
- 8) Devices must be baked for 1 hour at 60 ± 5 °C, if baking is required.
- 9) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.
- 11) Risk of sulfurization (or tarnishing)

The LED from Samsung does not use a silver-plated lead frame but if the LED is attached in silver-plated substrate, the surface color of substrate may change to black (or dark colored) when it is exposed to sulfur (S), chlorine (Cl) or other halogen compound. Sulfurization of substrate may cause intensity degradation, change of chromaticity coordinates and, in extreme cases, open circuit. It requires caution. Due to possible sulfurization of substrate, LED should not be used and stored together with oxidizing substances made of materials such as rubber, plain paper, lead solder cream, etc.

Legal and additional information.

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The company is redefining the worlds of TVs, smartphones, wearable devices, tablets, digital appliances, network systems, and memory, system LSI, foundry and LED solutions. For the latest news, please visit the Samsung Newsroom at news.samsung.com.

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